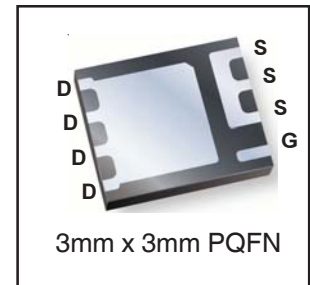
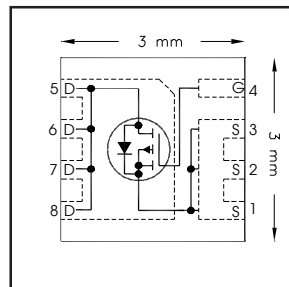


V_{DS}	-30	V
$R_{DS(on) max}$ (@ $V_{GS} = -10V$)	14.6	mΩ
Q_g (typical)	32	nC
I_D (@ $T_A = 25^\circ C$)	-11	A



Applications

- System/load switch

Features and Benefits

Features

Low Thermal Resistance to PCB (<6.0°C/W)
Compatible with Existing Surface Mount Techniques
RoHS Compliant Containing no Lead, no Bromide and no Halogen
MSL1, Consumer Qualification

results in

⇒

Benefits

Enable better thermal dissipation
Easier Manufacturing
Environmentally Friendlier
Increased Reliability

Orderable part number	Package Type	Standard Pack		Note
		Form	Quantity	
IRFHM9331TRPbF	PQFN 3mm x 3mm	Tape and Reel	4000	
IRFHM9331TR2PbF	PQFN 3mm x 3mm	Tape and Reel	400	EOL notice # 259

Absolute Maximum Ratings

	Parameter	Max.	Units
V_{DS}	Drain-to-Source Voltage	-30	V
V_{GS}	Gate-to-Source Voltage	± 25	
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ -10V$	-11	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current, $V_{GS} @ -10V$	-9	
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ -10V$	-24 ^⑦	
$I_D @ T_C = 70^\circ C$	Continuous Drain Current, $V_{GS} @ -10V$	-24	
I_{DM}	Pulsed Drain Current ^①	-90	
$P_D @ T_A = 25^\circ C$	Power Dissipation ^④	2.8	W
$P_D @ T_A = 70^\circ C$	Power Dissipation ^④	1.8	
	Linear Derating Factor	0.02	W/°C
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 150	°C

Notes ^① through ^⑦ are on page 2

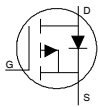
Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	-30	—	—	V	V _{GS} = 0V, I _D = -250μA
ΔBV _{DSS} /ΔT _J	Breakdown Voltage Temp. Coefficient	—	0.02	—	V/°C	Reference to 25°C, I _D = -1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance	—	10.0	—	mΩ	V _{GS} = -20V, I _D = -11A ③
		—	11.7	14.6		V _{GS} = -10V, I _D = -11A ③
V _{GS(th)}	Gate Threshold Voltage	-1.3	-1.8	-2.4	V	V _{DS} = V _{GS} , I _D = -25μA
ΔV _{GS(th)}	Gate Threshold Voltage Coefficient	—	-5.1	—	mV/°C	
I _{DSS}	Drain-to-Source Leakage Current	—	—	-1.0	μA	V _{DS} = -24V, V _{GS} = 0V
		—	—	-150		V _{DS} = -24V, V _{GS} = 0V, T _J = 125°C
I _{GSS}	Gate-to-Source Forward Leakage	—	—	-10	μA	V _{GS} = -25V
	Gate-to-Source Reverse Leakage	—	—	10		V _{GS} = 25V
g _{fs}	Forward Transconductance	16	—	—	S	V _{DS} = -10V, I _D = -9.0A
Q _g	Total Gate Charge ⑥	—	16	—	nC	V _{DS} = -15V, V _{GS} = -4.5V, I _D = -9.0A
Q _g	Total Gate Charge ⑥	—	32	48	nC	V _{GS} = -10V
Q _{gs}	Gate-to-Source Charge ⑥	—	4.4	—		V _{DS} = -15V
Q _{gd}	Gate-to-Drain Charge ⑥	—	8	—		I _D = -9.0A
R _G	Gate Resistance ⑥	—	16	—	Ω	
t _{d(on)}	Turn-On Delay Time	—	11	—	ns	V _{DD} = -15V, V _{GS} = -4.5V ③
t _r	Rise Time	—	27	—		I _D = -1.0A
t _{d(off)}	Turn-Off Delay Time	—	72	—		R _G = 6.8Ω
t _f	Fall Time	—	60	—		See Figs. 19a & 19b
C _{iss}	Input Capacitance	—	1543	—	pF	V _{GS} = 0V
C _{oss}	Output Capacitance	—	310	—		V _{DS} = -25V
C _{rss}	Reverse Transfer Capacitance	—	208	—		f = 1.0KHz

Avalanche Characteristics

	Parameter	Typ.	Max.	Units
E _{AS}	Single Pulse Avalanche Energy ②	—	76	mJ
I _{AR}	Avalanche Current ①	—	-9.0	A

Diode Characteristics

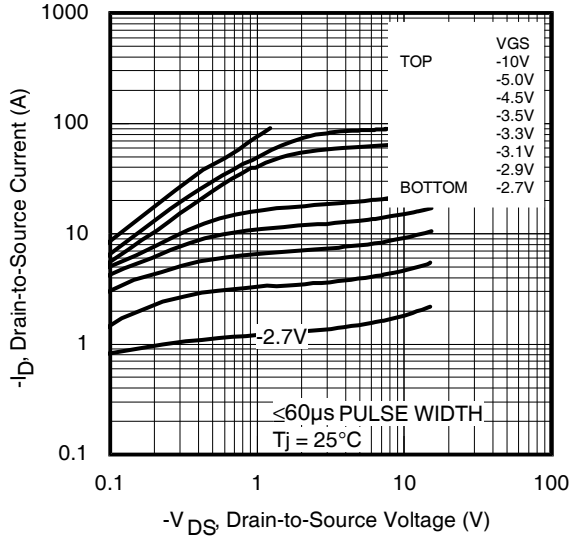
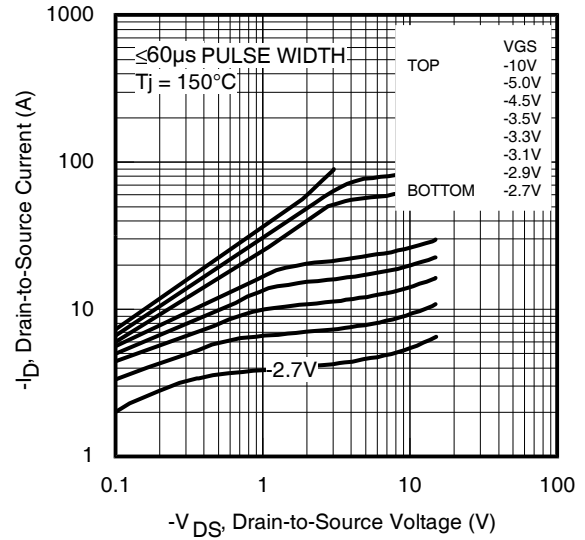
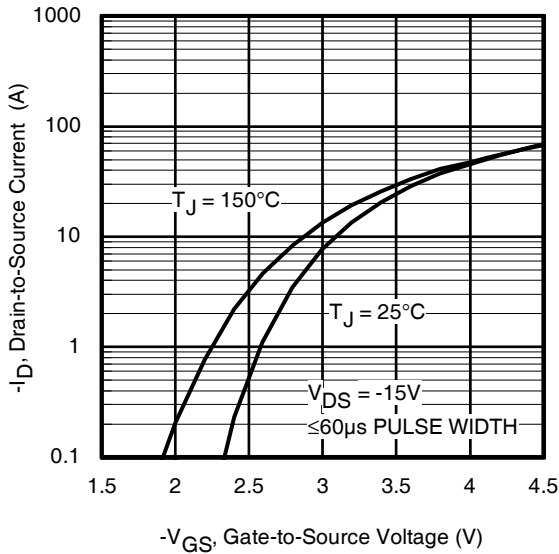
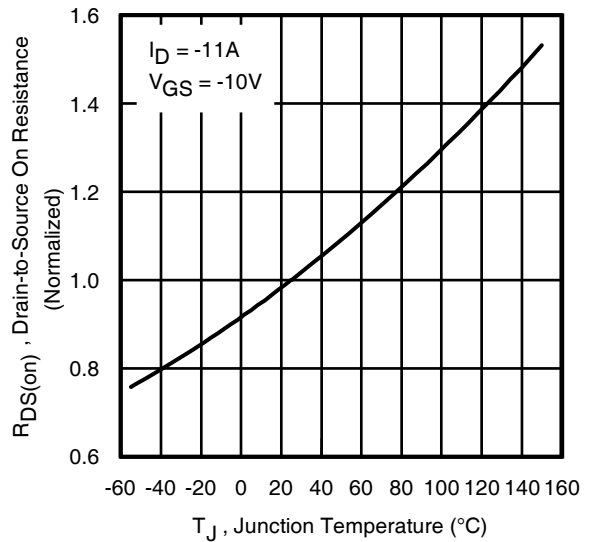
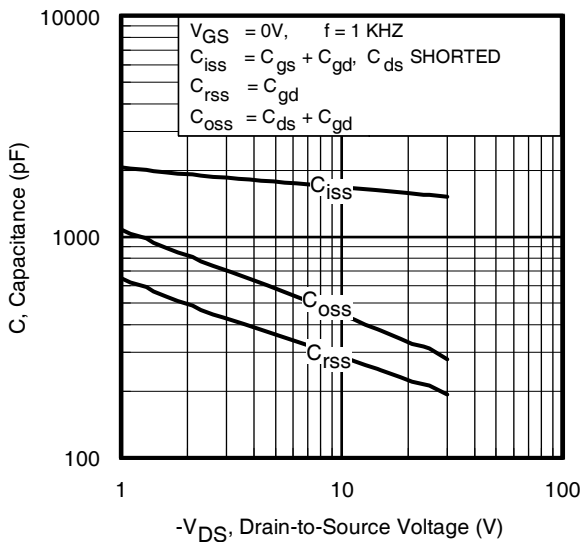
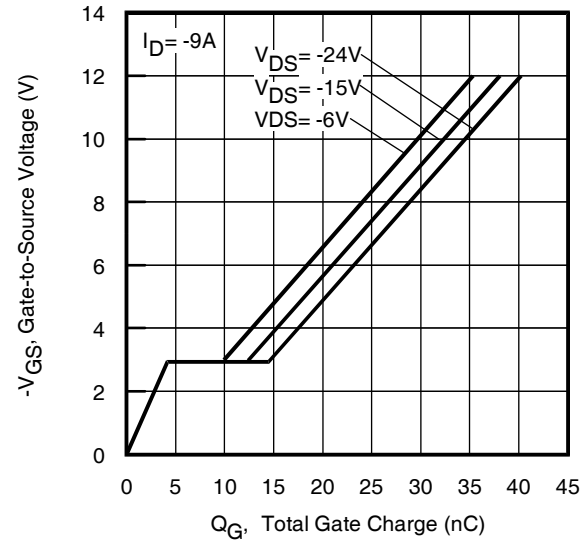
	Parameter	Min.	Typ.	Max.	Units	Conditions
I _S	Continuous Source Current (Body Diode)	—	—	-2.8	A	MOSFET symbol showing the integral reverse p-n junction diode. 
I _{SM}	Pulsed Source Current (Body Diode) ①	—	—	-90		
V _{SD}	Diode Forward Voltage	—	—	-1.2	V	T _J = 25°C, I _S = -2.8A, V _{GS} = 0V ③
t _{rr}	Reverse Recovery Time	—	64	96	ns	T _J = 25°C, I _F = -2.8A, V _{DD} = -24V
Q _{rr}	Reverse Recovery Charge	—	25	38	nC	di/dt = 100/μs ③

Thermal Resistance

	Parameter	Typ.	Max.	Units
R _{θJC}	Junction-to-Case ④	—	6	°C/W
R _{θJA}	Junction-to-Ambient ④	—	45	
R _{θJA}	Junction-to-Ambient (t<10s) ④	—	30	

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting T_J = 25°C, L = 1.904mH, R_G = 50Ω, I_{AS} = -9A.
- ③ Pulse width ≤ 400μs; duty cycle ≤ 2%.
- ④ When mounted on 1 inch square copper board.
- ⑤ R_θ is measured at T_J of approximately 90°C.
- ⑥ For DESIGN AID ONLY, not subject to production testing.
- ⑦ Current limited by package.


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics

Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance vs. Temperature

Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

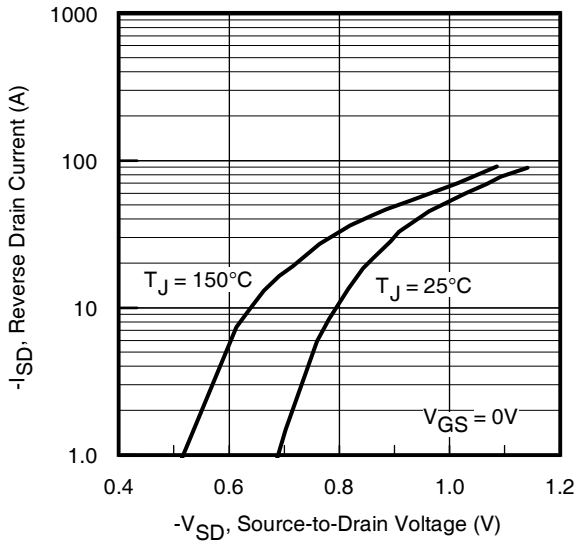


Fig 7. Typical Source-Drain Diode Forward Voltage

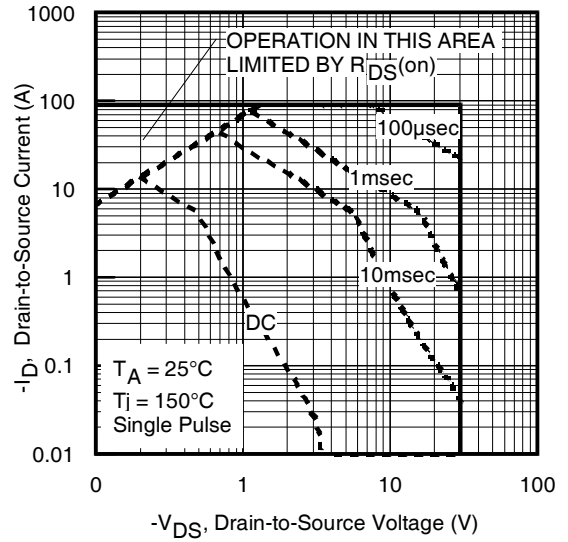


Fig 8. Maximum Safe Operating Area

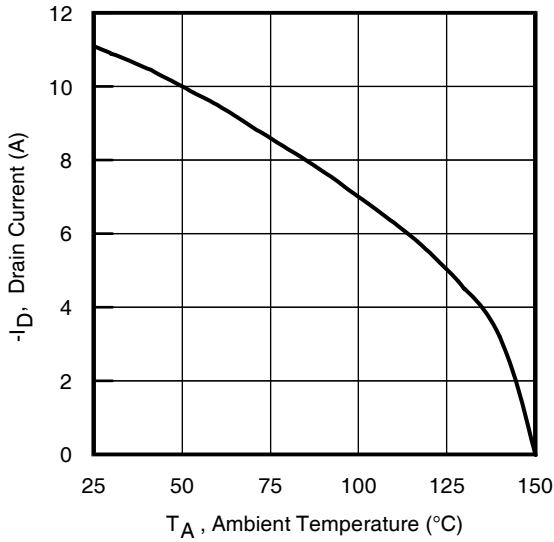


Fig 9. Maximum Drain Current vs. Ambient Temperature

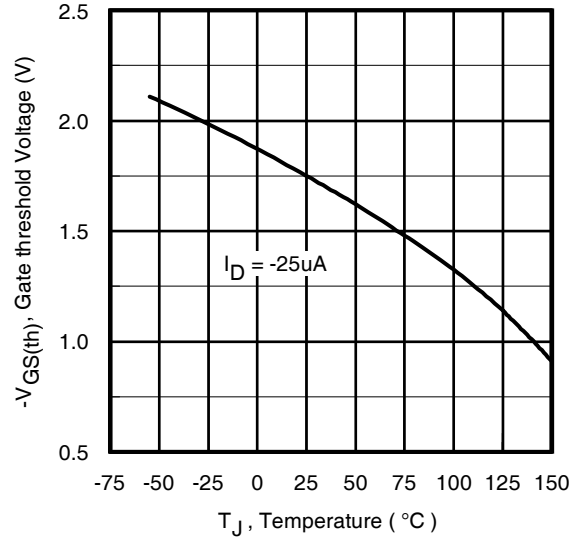


Fig 10. Threshold Voltage vs. Temperature

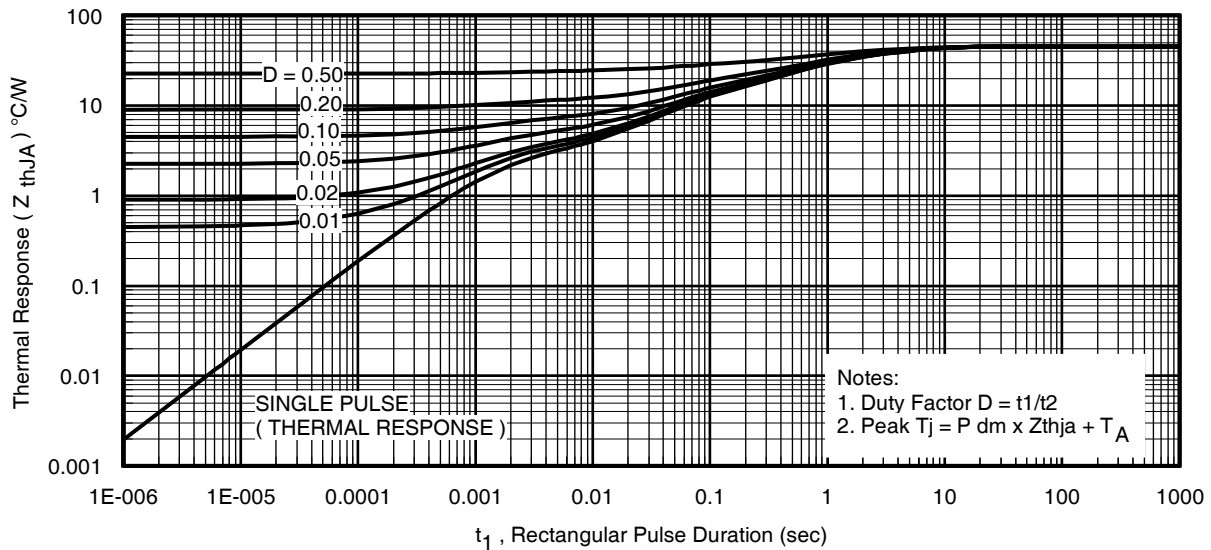
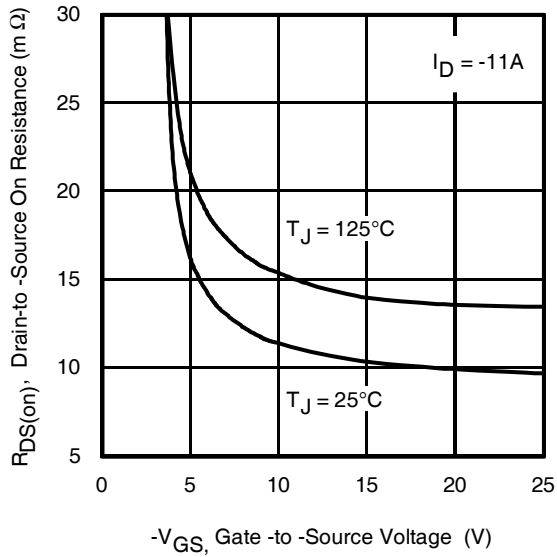
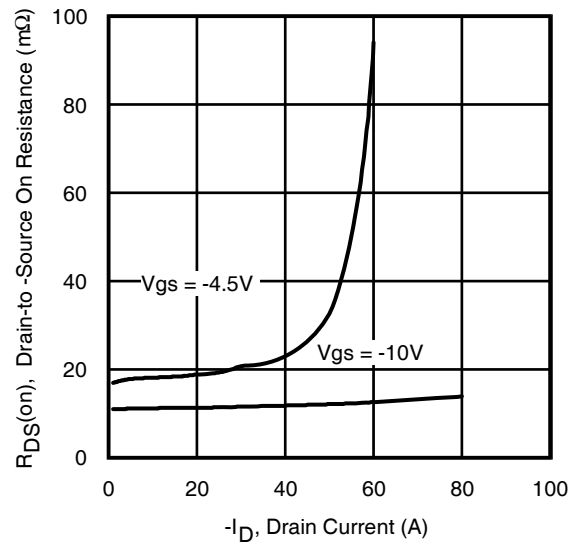
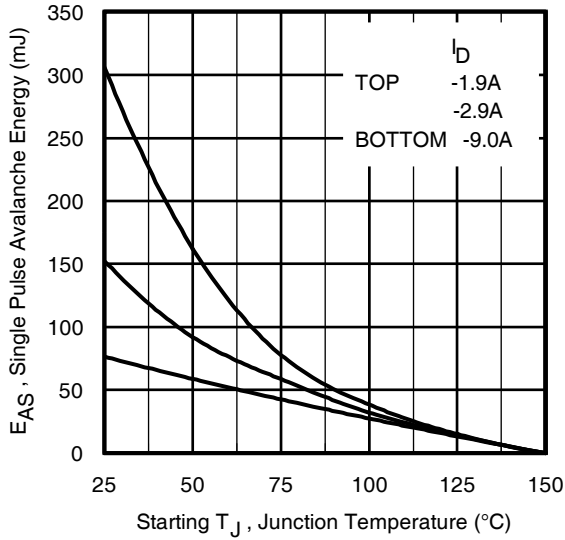
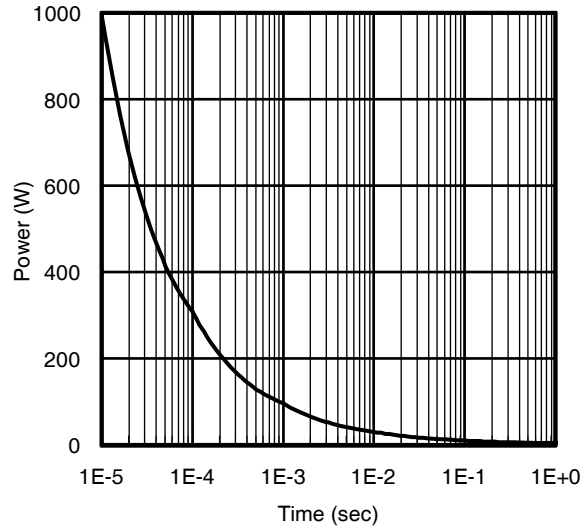
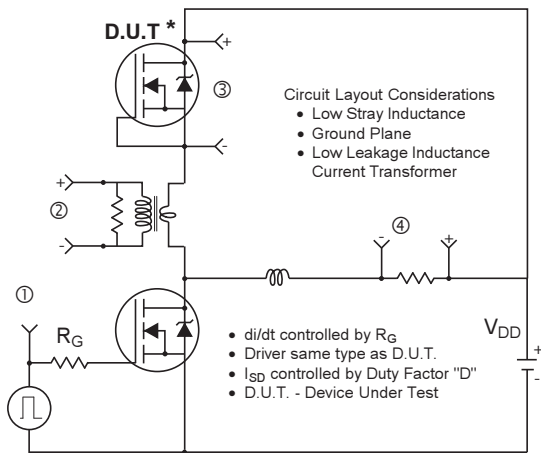
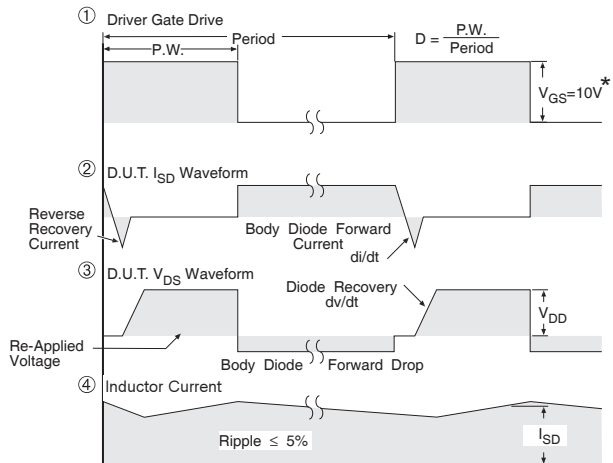


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient


Fig 12. On-Resistance vs. Gate Voltage

Fig 13. Typical On-Resistance vs. Drain Current

Fig 14. Maximum Avalanche Energy vs. Drain Current

Fig 15. Typical Power vs. Time


* Reverse Polarity of D.U.T. for P-Channel



* $V_{GS} = 5V$ for Logic Level Devices

Fig 16. Diode Reverse Recovery Test Circuit for P-Channel HEXFET® Power MOSFETs

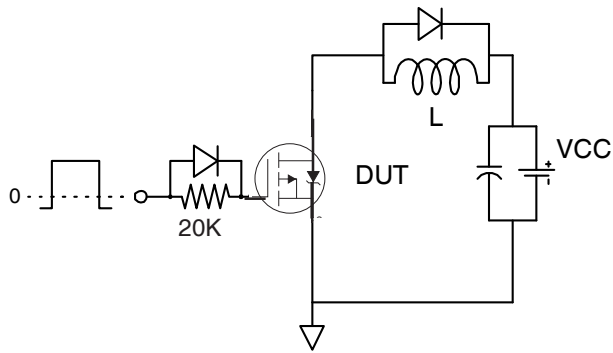


Fig 17a. Gate Charge Test Circuit

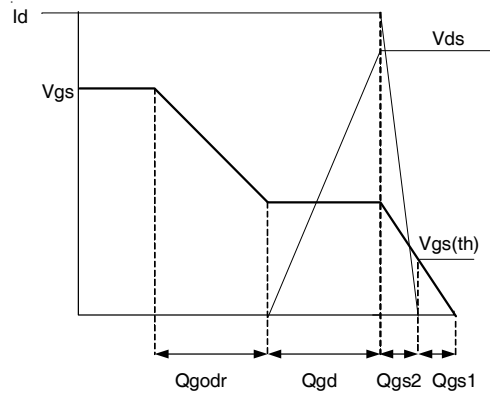


Fig 17b. Gate Charge Waveform

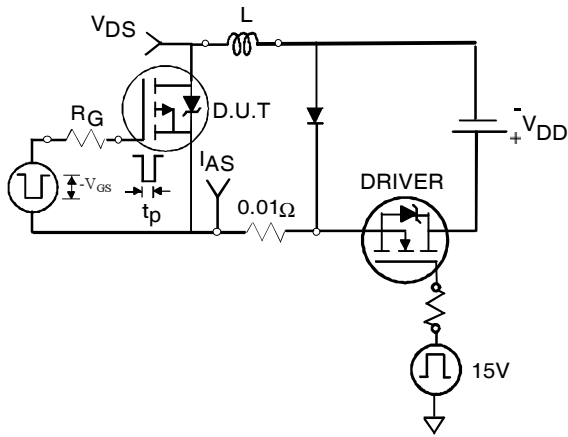


Fig 18a. Unclamped Inductive Test Circuit



Fig 18b. Unclamped Inductive Waveforms

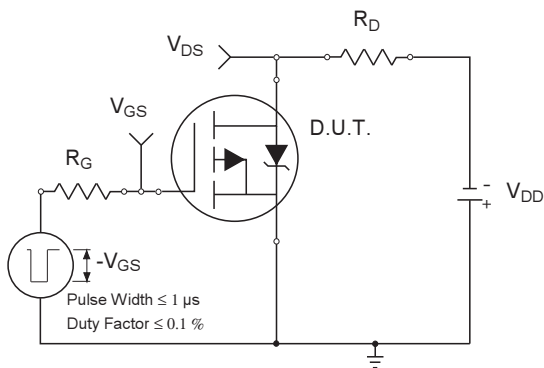


Fig 19a. Switching Time Test Circuit

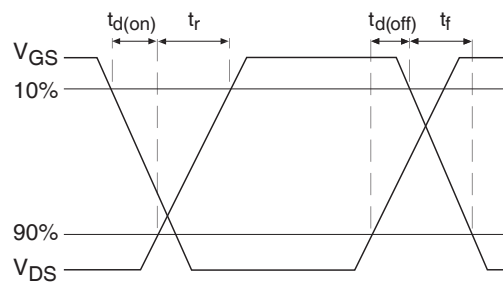
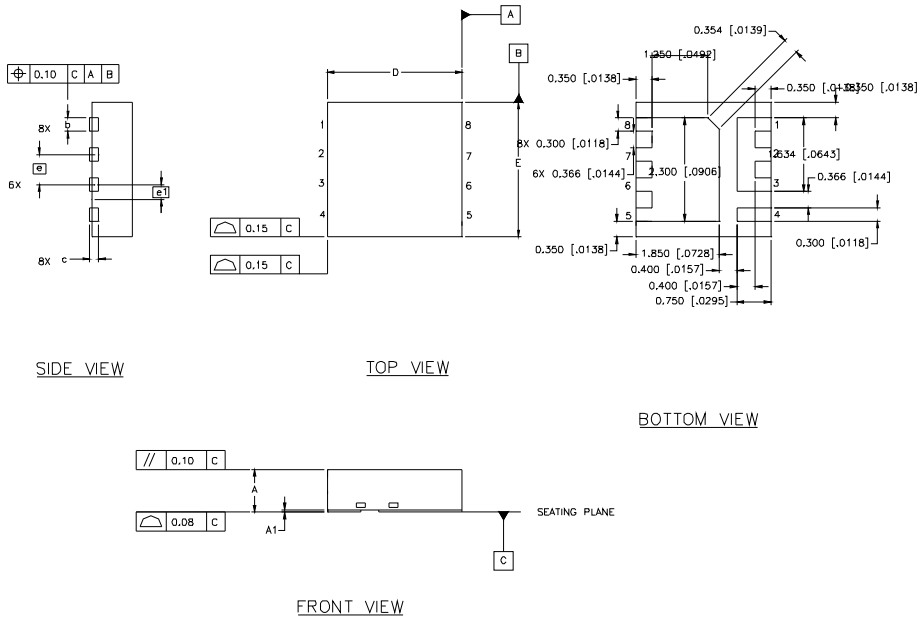


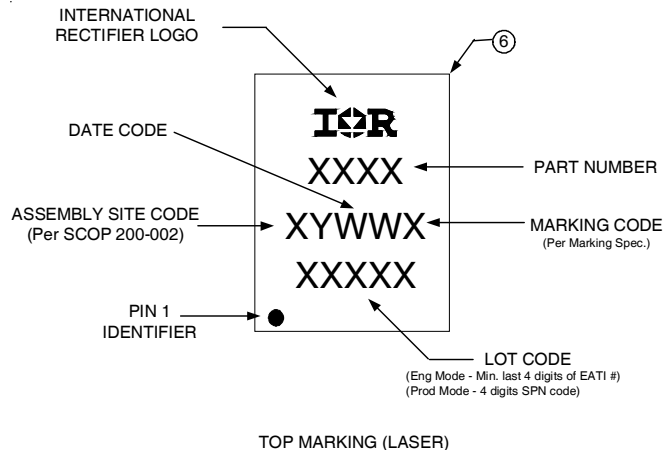
Fig 19b. Switching Time Waveforms

PQFN Package Details



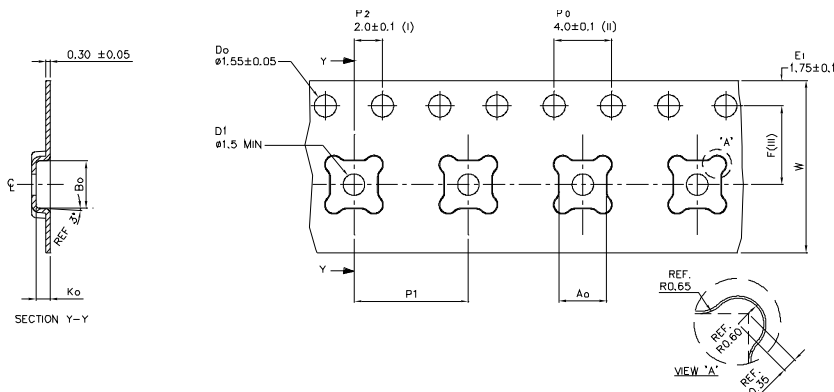
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0315	.0394	0.800	1.000
A1	.0000	.0020	0.000	0.050
b	.0098	.0138	0.250	0.350
c	.0080 REF.		0.203 REF.	
D	.1181 BASIC		3.000 BASIC	
E	.1181 BASIC		3.000 BASIC	
e	.0262 BASIC		0.666 BASIC	
e1	.0131 BASIC		0.333 BASIC	

PQFN Part Marking



Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>

PQFN Tape and Reel



Ao	3.30	+/- 0.1
B0	3.30	+/- 0.1
K0	1.00	+/- 0.1
F	5.50	+/- 0.1
P1	8.00	+/- 0.1
W	12.00	+/- 0.3

- (i) Measured from centreline of sprocket hole to centreline of pocket.
- (ii) Cumulative tolerance of 10 sprocket holes is ± 0.20 .
- (iii) Measured from centreline of sprocket hole to centreline of pocket.
- (iv) Other material available.

ALL DIMENSIONS IN MILLIMETRES UNLESS OTHERWISE STATED.

Qualification information[†]

Qualification level	Consumer ^{††} (per JEDEC JESD47F ^{†††} guidelines)	
Moisture Sensitivity Level	PQFN 3mm x 3mm	MSL1 (per IPC/JEDEC J-ST D-020D ^{†††})
RoHS compliant	Yes	

[†] Qualification standards can be found at International Rectifier's web site

<http://www.irf.com/product-info/reliability>

^{††} Higher qualification ratings may be available should the user have such requirements.

Please contact your International Rectifier sales representative for further information:

<http://www.irf.com/whoto-call/salesrep/>

^{†††} Applicable version of JEDEC standard at the time of product release.

Revision History

Date	Comments
12/16/2013	<ul style="list-style-type: none"> • Updated ordering information to reflect the End-Of-life (EOL) of the mini-reel option (EOL notice #259) • Updated data sheet with new IR corporate template



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Промышленная ул, дом № 19, литера Н,
помещение 100-Н Офис 331